

MC9S08DZ32AMLC (Active)

S08DZ 8-bit MCU, S08 core, 32KB Flash, 40MHz, QFP 32

- Data Sheet
- Software & Tools

- Product Summary
- Documentation



Package :
LQFP

plastic, low profile quad; flat
leaded package; 32 terminals;
0.80 mm pitch; 7 mm x 7 mm x 1.4
mm body

Buy Options

Operating Characteristics

Environmental Information

Quality Information

Shipping Information

Operating Characteristics

Parameter	Value
Flash (kB)	32
RAM (kB)	2
EEPROM (kB)	1
Core Type	S08
Operating Frequency [Max (MHz)]	20
I ² C	1

Parameter	Value
SPI	1
Supply voltage [min] (V)	2.7
Supply voltage [max] (V)	5.5
GPIO	26
Ambient Operating Temperature (Min-Max) (°C)	-40 to 85
SCI	2

Environmental Information

Material Declaration	PbFree	EU RoHS	Halogen Free	RHF Indicator	2nd Level Interconnect	REACH SVHC	Weight (mg)
<a>MC9S08DZ32AMLC (935324271557)	Yes	Yes <a>Certificate Of Analysis (CoA)	Yes	D	e3	<a>REACH SVHC	188.6

Quality Information

Material Declaration	Safe Assure Functional Safety	Moisture Sensitivity Level (MSL)	Peak Package Body Temperature (PPT) (C°)	Maximum Time at Peak Temperatures (s)
		Lead Free Soldering	Lead Free Soldering	Lead Free Soldering
<a>MC9S08DZ32AMLC (935324271557)	No	3	260	40

Shipping Information

Part Number	Harmonized Tariff (US) <a>Disclaimer	Export Control Classification Number (US)
<a>MC9S08DZ32AMLC (935324271557)	854231	3A991A2

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